

ALL-IN-ONE MACHINE FOR HYBRID TECHNOLOGIES ENABLING HIGH VALUE-ADDED MULTI-SCALE INTEGRATED MICRO-OPTOELECTRONICS

> THE MANUFACTURING PARTNERSHIP DAY BRUSSELS - SEPTEMBER 26TH 2023

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SUPSI



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MISSION OF MESOMORPH

Enable a new generation of microelectromechanical systems, micro-sensors and micro-devices.

Applications in Electronics, Health diagnostics, Optics, and Environmental monitoring.

Necessity of combining different technologies:

- Multi-material deposition
- Multi-material subtraction/modification

MESOMORPH MACHINE

MESIMIRPH

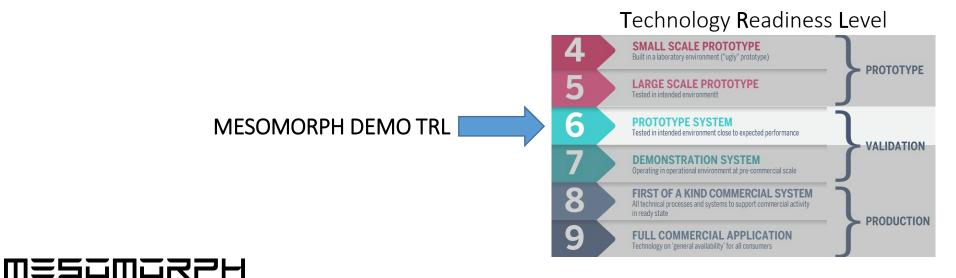


PROJECT OBJECTIVES

Mesomorph will deliver a **TRL6 demo** of a new generation of **all-in-one machine** integrating three disruptive technologies:

- Femto-laser treatments
- Two-Photon Polymerization (2PP)
- Atomic layer 3D nano-printing (Selective Area Direct Atomic Layer Processing SADALP)

In a small self-contained *room*, implemented with a complete a sensing system able to both close the loop on the process execution, and check the partial results to quick react to deviation correcting the production processes accordingly.



MESOMORPH EXPECTED IMPACT

20% reduction of production time

Increased automation level

Higher precision

- Multiscale 3D printing
- ➤ High throughput ablation
- Sensor-guided assembly
- > -70% assembly steps
- All technologies integrated into one machine
- > 100nm z resolution
- > 300nm x; y resolution
- Submicron accuracy

Zero rejection rate

 Adaptive control +3D in-line inspection Mesomorph product solutions will result from a **fully automated compact process chain** ensuring:

lead-time for a new product <4 weeks;</p>

➤ scrap rate < 0.01%.</p>

They will present enhanced performances as a consequence of the ability to reach:

- > 50'000 Parts/year throughput;
- > 300 nm x; y resolution;

The number of technologies available on board and the number of materials that can be processed will widely enlarge the opportunity for:

- Rapid evolution of products;
- Quick and automated industrialization and ramp-up <1 week.</p>



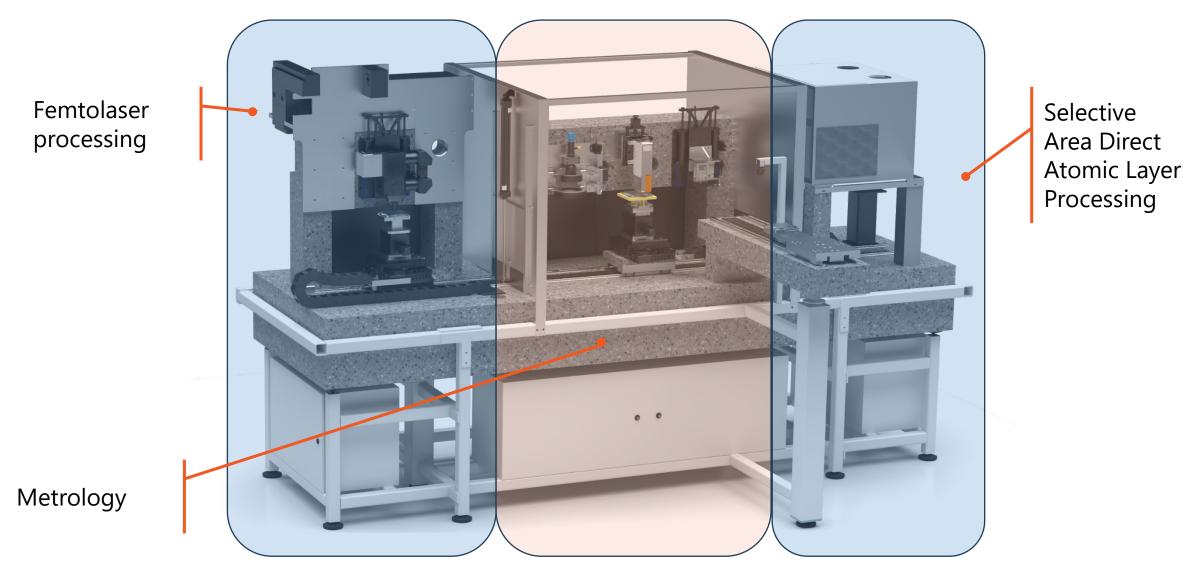
PROJECT CONSORTIUM

END-USERS	

- SYSTEM DESIGN & INTEGRATION
- PROCESS DESIGN & ENGINEERING

			Participant legal name	Short Name	Country	Organization type
	⇒ [1	Prima Electro	PE	IT	LE - Integrator of the machine and control platform
•	⇒	2	Scuola Universitaria Professionale della Svizzera Italiana	SUPSI	СН	RTD - Machine designer, integrator and process engineering
	→	3	IRIS	IRIS	IT	SME - Design and engineering process of microfluid sensors for water applications. Overall standardization features.
END-USERS	→	4	Femtika	FEMTIKA	LT	SME – Provider of Femto laser and 2PP processing technology and know-how
SYSTEM DESIGN &	→	5	Atlant 3D	ATLANT	DK	SME – Provider of SADALP processing technology and know-how
INTEGRATION	➡ [6	nLight	NLIGHT	IT	SME - Design for assembly of micro-systems
PROCESS DESIGN &	→	7	Morphica	MORPHICA	IT	SME - Design/Manufacturing-to-Lifevalue Platform and exploitation support
MULTI-TECH PRODUCT DESIGN	→	8	Friedrich-Alexander- Universität Erlangen- Nürnberg	FAU	DE	RTD - Chemical processes engineering of SADALP process
•	➡	9	Politecnico di Torino	POLITO	IT	RTD – Expertise provider on microsystems design
	→	10	STMicroelectronics	ST	IT	LE – Design and engineering process support on the next generation industrial and automotive sensors
	→	11	Yalosys	YALOSYS	СН	SME - Support to the engineering of health and medtech sensors
•	⇒	12	Heliotis	HELIOTIS	СН	SME – Technology provider and integrator of ultra-fast scanners for micro inspection
MESOMORPH	⇒ [13	MCH-TRONICS	МСН	СН	SME - Integrators of the machine and control platform

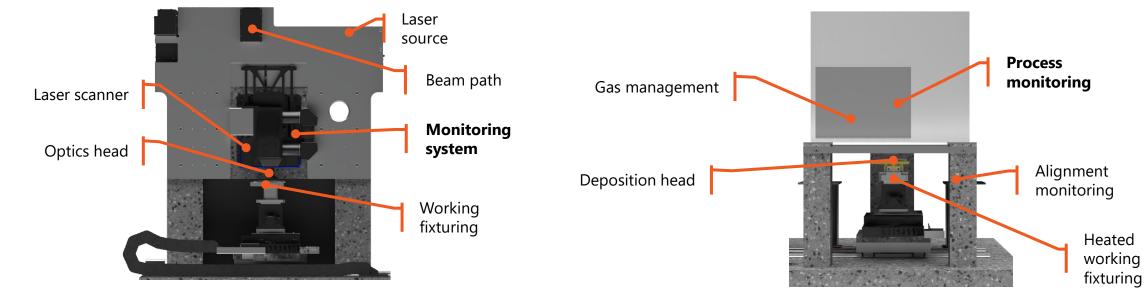
INTERNAL STRUCTURE





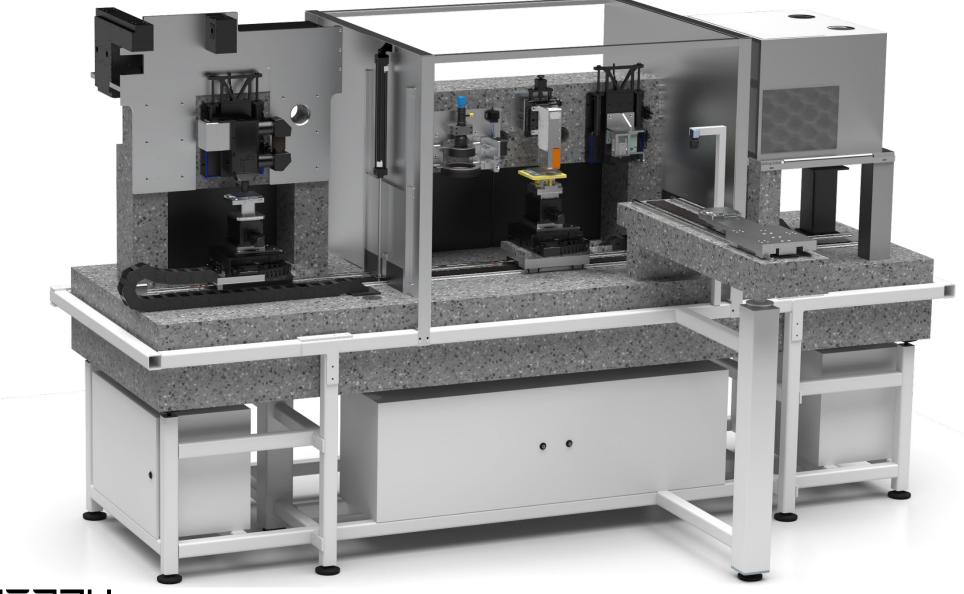
MESOMORPH "PRODUCTION" MODULES

Process	Module	Basic function	Definition	Resolution	Material
Two-Photon Polimerization (2PP)	FEMTO	Add	Fusing and curing processes	300nm	Any photosensitive precursor
Femtosecond ablation		Subtract	Ultra-short laser ablate material enabling superficial structuring, grooving and marking		Any material (↗ reflectivity = ↘ throughput)
Selective Area Direct Atomic Layer Processing	SADALP	ADD	Molecules are deposited in a vapour form and reactions are directly triggered on the deposition site.	300nm (100nm z- resolution)	400 precursors to deposit 150 oxides
Verification	Metrology	Check	Three different technologies able to measure all the materials with high resolution		



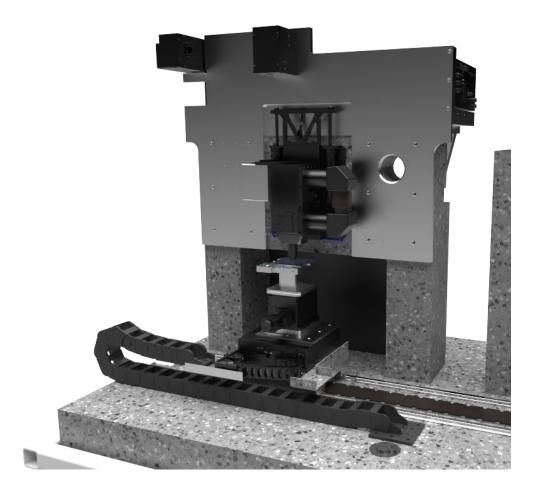


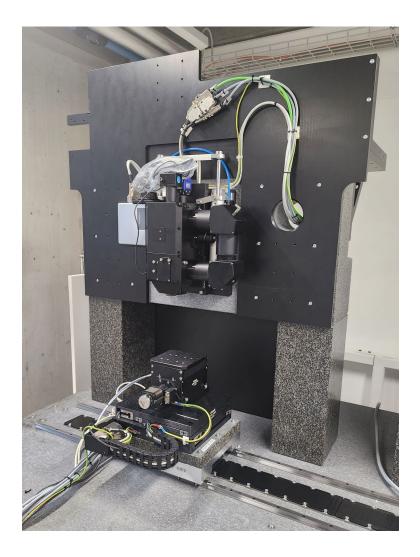
MESOMORPH FULL INTERNAL MACHINE





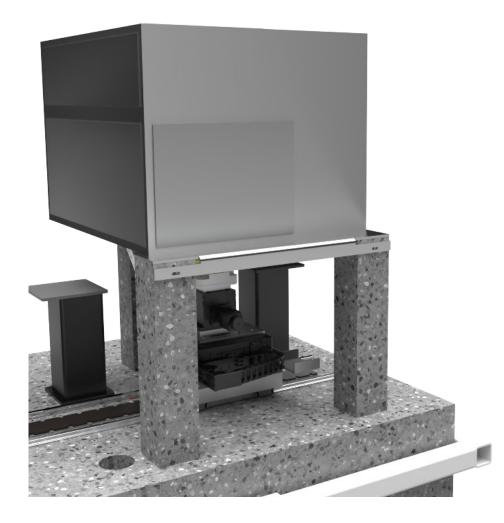
FEMTOLASER MODULE





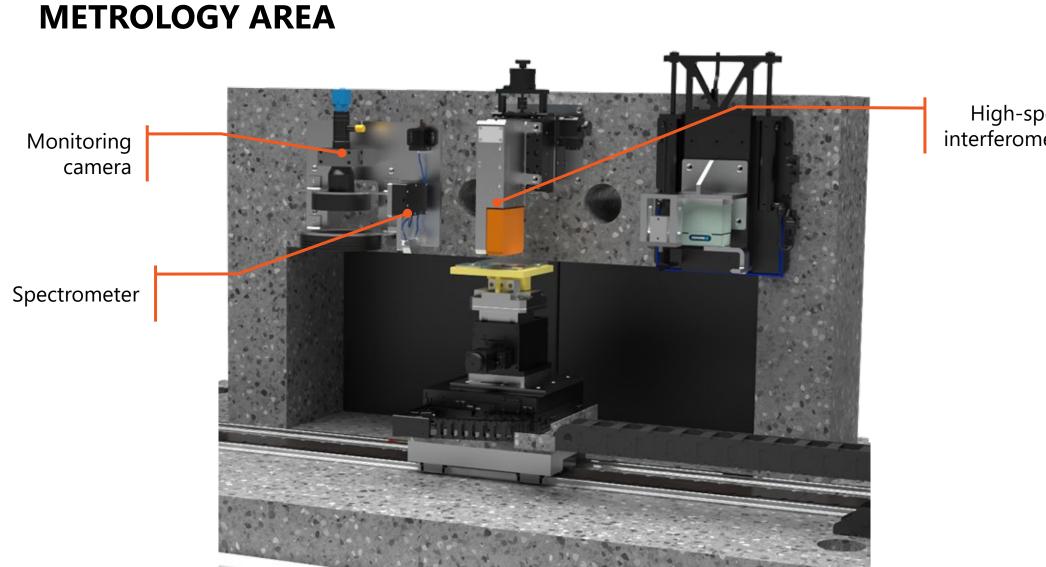


SADALP MODULE









High-speed interferometer



MESOMORPH EXPLOITABLE RESULTS



Exploitable result	Leader	Partners involved	Means of exploitation
Mesomorph integrated concept equipment	PE	MCH, SUPSI	New product (integrated equipment), Commercial agreements with RTD providers
SADALP process and unit	ATLANT	FAU, MCH	New product (equipment for SADALP process), Licensing / IPR agreements
Femtosecond laser and 2PP process and unit	FEMTIKA	SUPSI, MCH	Adaptation of own processes to ease integration in Mesomorph concept, commercial agreements with PE
Gripping and moving unit	NLIGHT	POLITO, MCH	Adaptation of own processes to ease integration in Mesomorph concept, commercial agreements with PE
Scanners for micro inspection	HELIOTIS	МСН	Adaptation of own product to ease integration in Mesomorph concept, commercial agreements with PE
Design/Manufacturi ng-to-Lifevalue Platform	MORPHICA	ST, SMOLSYS, IRIS	Adaptation of own digital platform to ease integration in Mesomorph concept, commercial agreements with PE
New corrosion sensor	ST	SUPSI	New product (microsensors for industrial applications)
New Health sensor	SMOLSYS	SUPSI	New product (ingestible microsensors for smart diagnosis)
New Water sensor	IRIS	SUPSI	New process (real time monitoring of water quality)



THANK YOU



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